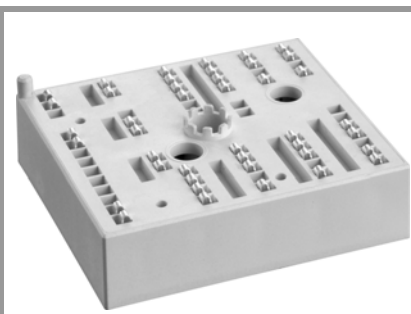




MiniSKiiP® 2

## Converter-Inverter-Brake (CIB)

### SKiiP 24NAB12T4V1

#### Features\*

- Trench 4 IGBTs
- Robust and soft switching freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognized: File no. E63532

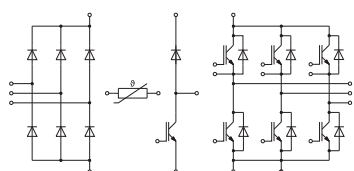
#### Typical Applications

- Inverter up to 22 kVA
- Typical motor power 11 kW

#### Remarks

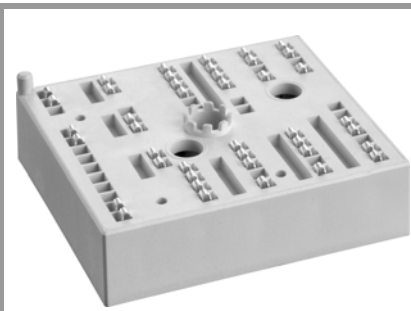
- Case temp. limited to  $T_C = 125^\circ\text{C}$  max. (for baseplateless modules  $T_C = T_S$ )
- product rel. results valid for  $T_j \leq 150$  (recomm.  $T_{op} = -40 \dots +150^\circ\text{C}$ )

| Absolute Maximum Ratings |                                                                                |                         |             |      |
|--------------------------|--------------------------------------------------------------------------------|-------------------------|-------------|------|
| Symbol                   | Conditions                                                                     |                         | Values      | Unit |
| Inverter - IGBT          |                                                                                |                         |             |      |
| V <sub>CES</sub>         | T <sub>j</sub> = 25 °C                                                         |                         | 1200        | V    |
| I <sub>C</sub>           | λ <sub>paste</sub> =0.8 W/(mK)                                                 | T <sub>s</sub> = 25 °C  | 48          | A    |
|                          | T <sub>j</sub> = 175 °C                                                        | T <sub>s</sub> = 70 °C  | 39          | A    |
| I <sub>C</sub>           | λ <sub>paste</sub> =2.5 W/(mK)                                                 | T <sub>s</sub> = 25 °C  | 53          | A    |
|                          | T <sub>j</sub> = 175 °C                                                        | T <sub>s</sub> = 70 °C  | 43          | A    |
| I <sub>Cnom</sub>        |                                                                                |                         | 35          | A    |
| I <sub>CRM</sub>         |                                                                                |                         | 105         | A    |
| V <sub>GES</sub>         |                                                                                |                         | -20 ... 20  | V    |
| t <sub>psc</sub>         | V <sub>CC</sub> = 800 V<br>V <sub>GE</sub> ≤ 15 V<br>V <sub>CES</sub> ≤ 1200 V | T <sub>j</sub> = 150 °C | 10          | μs   |
| T <sub>j</sub>           |                                                                                |                         | -40 ... 175 | °C   |
| Chopper - IGBT           |                                                                                |                         |             |      |
| V <sub>CES</sub>         | T <sub>j</sub> = 25 °C                                                         |                         | 1200        | V    |
| I <sub>C</sub>           | λ <sub>paste</sub> =0.8 W/(mK)                                                 | T <sub>s</sub> = 25 °C  | 48          | A    |
|                          | T <sub>j</sub> = 175 °C                                                        | T <sub>s</sub> = 70 °C  | 39          | A    |
| I <sub>C</sub>           | λ <sub>paste</sub> =2.5 W/(mK)                                                 | T <sub>s</sub> = 25 °C  | 53          | A    |
|                          | T <sub>j</sub> = 175 °C                                                        | T <sub>s</sub> = 70 °C  | 43          | A    |
| I <sub>Cnom</sub>        |                                                                                |                         | 35          | A    |
| I <sub>CRM</sub>         |                                                                                |                         | 105         | A    |
| V <sub>GES</sub>         |                                                                                |                         | -20 ... 20  | V    |
| t <sub>psc</sub>         | V <sub>CC</sub> = 800 V<br>V <sub>GE</sub> ≤ 15 V<br>V <sub>CES</sub> ≤ 1200 V | T <sub>j</sub> = 150 °C | 10          | μs   |
| T <sub>j</sub>           |                                                                                |                         | -40 ... 175 | °C   |
| Inverse - Diode          |                                                                                |                         |             |      |
| V <sub>RRM</sub>         | T <sub>j</sub> = 25 °C                                                         |                         | 1200        | V    |
| I <sub>F</sub>           | λ <sub>paste</sub> =0.8 W/(mK)                                                 | T <sub>s</sub> = 25 °C  | 44          | A    |
|                          | T <sub>j</sub> = 175 °C                                                        | T <sub>s</sub> = 70 °C  | 35          | A    |
| I <sub>F</sub>           | λ <sub>paste</sub> =2.5 W/(mK)                                                 | T <sub>s</sub> = 25 °C  | 49          | A    |
|                          | T <sub>j</sub> = 175 °C                                                        | T <sub>s</sub> = 70 °C  | 40          | A    |
| I <sub>FRM</sub>         |                                                                                |                         | 105         | A    |
| I <sub>FSM</sub>         | t <sub>p</sub> = 10 ms, sin 180°, T <sub>j</sub> = 150 °C                      |                         | 170         | A    |
| T <sub>j</sub>           |                                                                                |                         | -40 ... 175 | °C   |
| Freewheeling - Diode     |                                                                                |                         |             |      |
| V <sub>RRM</sub>         | T <sub>j</sub> = 25 °C                                                         |                         | 1200        | V    |
| I <sub>F</sub>           | λ <sub>paste</sub> =0.8 W/(mK)                                                 | T <sub>s</sub> = 25 °C  | 44          | A    |
|                          | T <sub>j</sub> = 175 °C                                                        | T <sub>s</sub> = 70 °C  | 35          | A    |
| I <sub>F</sub>           | λ <sub>paste</sub> =2.5 W/(mK)                                                 | T <sub>s</sub> = 25 °C  | 49          | A    |
|                          | T <sub>j</sub> = 175 °C                                                        | T <sub>s</sub> = 70 °C  | 40          | A    |
| I <sub>FRM</sub>         |                                                                                |                         | 105         | A    |
| I <sub>FSM</sub>         | t <sub>p</sub> = 10 ms, sin 180°, T <sub>j</sub> = 150 °C                      |                         | 170         | A    |
| T <sub>j</sub>           |                                                                                |                         | -40 ... 175 | °C   |



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# SKiiP 24NAB12T4V1



MiniSKiiP® 2

## Converter-Inverter-Brake (CIB)

### SKiiP 24NAB12T4V1

#### Features\*

- Trench 4 IGBTs
- Robust and soft switching freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognized: File no. E63532

#### Typical Applications

- Inverter up to 22 kVA
- Typical motor power 11 kW

#### Remarks

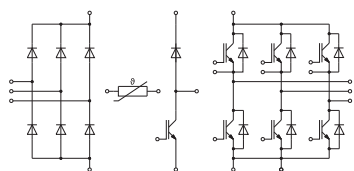
- Case temp. limited to  $T_C = 125^\circ\text{C}$  max. (for baseplateless modules  $T_C = T_S$ )
- product rel. results valid for  $T_j \leq 150$  (recomm.  $T_{op} = -40 \dots +150^\circ\text{C}$ )

#### Absolute Maximum Ratings

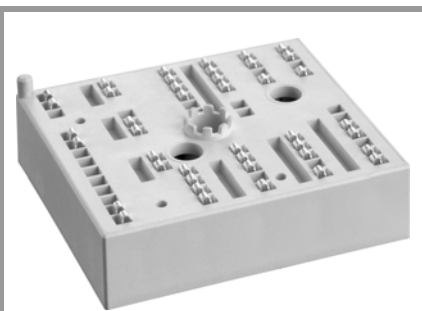
| Symbol              | Conditions                                     |                         | Values      | Unit             |
|---------------------|------------------------------------------------|-------------------------|-------------|------------------|
| Rectifier - Diode   |                                                |                         |             |                  |
| V <sub>RRM</sub>    | T <sub>j</sub> = 25 °C                         |                         | 1600        | V                |
| I <sub>F</sub>      | λ <sub>paste</sub> =0.8 W/(mK)                 | T <sub>s</sub> = 25 °C  | 52          | A                |
|                     | T <sub>j</sub> = 150 °C                        | T <sub>s</sub> = 70 °C  | 39          | A                |
| I <sub>F</sub>      | λ <sub>paste</sub> =2.5 W/(mK)                 | T <sub>s</sub> = 25 °C  | 57          | A                |
|                     | T <sub>j</sub> = 150 °C                        | T <sub>s</sub> = 70 °C  | 43          | A                |
| I <sub>FSM</sub>    | t <sub>p</sub> = 10 ms                         | T <sub>j</sub> = 25 °C  | 370         | A                |
|                     | sin 180°                                       | T <sub>j</sub> = 150 °C | 270         | A                |
| i <sup>2</sup> t    | t <sub>p</sub> = 10 ms                         | T <sub>j</sub> = 25 °C  | 685         | A <sup>2</sup> s |
|                     | sin 180°                                       | T <sub>j</sub> = 150 °C | 365         | A <sup>2</sup> s |
| T <sub>j</sub>      |                                                |                         | -40 ... 150 | °C               |
| Module              |                                                |                         |             |                  |
| I <sub>t(RMS)</sub> | T <sub>terminal</sub> = 80 °C, 20 A per spring |                         | 40          | A                |
| T <sub>stg</sub>    | module without TIM                             |                         | -40 ... 125 | °C               |
| V <sub>isol</sub>   | AC sinus 50 Hz, 1 min                          |                         | 2500        | V                |

#### Characteristics

| Symbol                 | Conditions                                                                    | min.                      | typ. | max. | Unit             |
|------------------------|-------------------------------------------------------------------------------|---------------------------|------|------|------------------|
| <b>Inverter - IGBT</b> |                                                                               |                           |      |      |                  |
| $V_{CE(sat)}$          | $I_C = 35 \text{ A}$<br>$V_{GE} = 15 \text{ V}$<br>chipelevel                 | $T_j = 25^\circ\text{C}$  | 1.85 | 2.10 | V                |
|                        |                                                                               | $T_j = 150^\circ\text{C}$ | 2.25 | 2.45 | V                |
| $V_{CE0}$              | chipelevel                                                                    | $T_j = 25^\circ\text{C}$  | 0.80 | 0.90 | V                |
|                        |                                                                               | $T_j = 150^\circ\text{C}$ | 0.70 | 0.80 | V                |
| $r_{CE}$               | $V_{GE} = 15 \text{ V}$<br>chipelevel                                         | $T_j = 25^\circ\text{C}$  | 30   | 34   | $\text{m}\Omega$ |
|                        |                                                                               | $T_j = 150^\circ\text{C}$ | 44   | 47   | $\text{m}\Omega$ |
| $V_{GE(th)}$           | $V_{GE} = V_{CE}$ , $I_C = 1 \text{ mA}$                                      | 5                         | 5.8  | 6.5  | V                |
| $I_{CES}$              | $V_{GE} = 0 \text{ V}$ , $V_{CE} = 1200 \text{ V}$ , $T_j = 25^\circ\text{C}$ |                           |      | 1    | mA               |
| $C_{ies}$              | $V_{CE} = 25 \text{ V}$<br>$V_{GE} = 0 \text{ V}$                             | $f = 1 \text{ MHz}$       | 1.95 |      | nF               |
| $C_{oes}$              |                                                                               | $f = 1 \text{ MHz}$       | 0.16 |      | nF               |
| $C_{res}$              |                                                                               | $f = 1 \text{ MHz}$       | 0.12 |      | nF               |
| $Q_G$                  | $V_{GE} = -8 \text{ V} \dots +15 \text{ V}$                                   |                           | 200  |      | nC               |
| $R_{Gint}$             | $T_j = 25^\circ\text{C}$                                                      |                           | 0    |      | $\Omega$         |
| $t_{d(on)}$            | $V_{CC} = 600 \text{ V}$                                                      | $T_j = 150^\circ\text{C}$ | 30   |      | ns               |
| $t_r$                  | $I_C = 35 \text{ A}$<br>$R_{G on} = 18 \Omega$                                | $T_j = 150^\circ\text{C}$ | 35   |      | ns               |
|                        |                                                                               | $T_j = 150^\circ\text{C}$ | 4.3  |      | mJ               |
| $E_{on}$               | $R_{G off} = 18 \Omega$                                                       | $T_j = 150^\circ\text{C}$ | 300  |      | ns               |
| $t_{d(off)}$           | $di/dt_{on} = 830 \text{ A}/\mu\text{s}$                                      | $T_j = 150^\circ\text{C}$ | 55   |      | ns               |
| $t_f$                  | $di/dt_{off} = 600 \text{ A}/\mu\text{s}$                                     | $T_j = 150^\circ\text{C}$ |      |      |                  |
| $E_{off}$              | $V_{GE} = +15/-15 \text{ V}$                                                  | $T_j = 150^\circ\text{C}$ | 3.25 |      | mJ               |
| $R_{th(j-s)}$          | per IGBT, $\lambda_{paste}=0.8 \text{ W/(mK)}$                                |                           | 1    |      | K/W              |
| $R_{th(j-s)}$          | per IGBT, $\lambda_{paste}=2.5 \text{ W/(mK)}$                                |                           | 0.82 |      | K/W              |



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MiniSKiiP® 2

## Converter-Inverter-Brake (CIB)

### SKiiP 24NAB12T4V1

#### Features\*

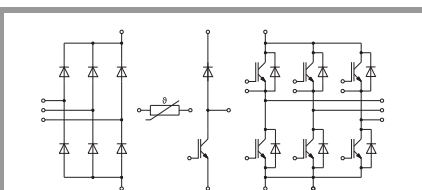
- Trench 4 IGBTs
- Robust and soft switching freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognized: File no. E63532

#### Typical Applications

- Inverter up to 22 kVA
- Typical motor power 11 kW

#### Remarks

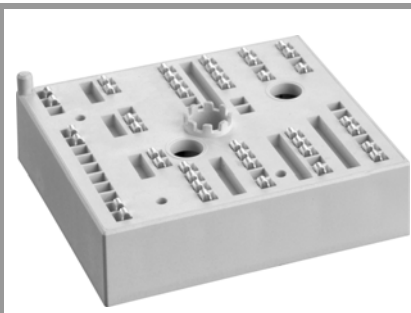
- Case temp. limited to  $T_C = 125^\circ\text{C}$  max. (for baseplateless modules  $T_C = T_S$ )
- product rel. results valid for  $T_j \leq 150$  (recomm.  $T_{op} = -40 \dots +150^\circ\text{C}$ )



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| Characteristics                  |                                                                         |                         |      |      |      |      |
|----------------------------------|-------------------------------------------------------------------------|-------------------------|------|------|------|------|
| Symbol                           | Conditions                                                              |                         | min. | typ. | max. | Unit |
| Chopper - IGBT                   |                                                                         |                         |      |      |      |      |
| V <sub>CE(sat)</sub>             | I <sub>C</sub> = 35 A                                                   | T <sub>J</sub> = 25 °C  |      | 1.85 | 2.10 | V    |
|                                  | V <sub>GE</sub> = 15 V<br>chipelevel                                    | T <sub>J</sub> = 150 °C |      | 2.25 | 2.45 | V    |
| V <sub>CE0</sub>                 | chipelevel                                                              | T <sub>J</sub> = 25 °C  |      | 0.80 | 0.90 | V    |
|                                  |                                                                         | T <sub>J</sub> = 150 °C |      | 0.70 | 0.80 | V    |
| r <sub>CE</sub>                  | V <sub>GE</sub> = 15 V<br>chipelevel                                    | T <sub>J</sub> = 25 °C  |      | 30   | 34   | mΩ   |
|                                  |                                                                         | T <sub>J</sub> = 150 °C |      | 44   | 47   | mΩ   |
| V <sub>GE(th)</sub>              | V <sub>GE</sub> = V <sub>CE</sub> , I <sub>C</sub> = 1 mA               |                         | 5    | 5.8  | 6.5  | V    |
| I <sub>CES</sub>                 | V <sub>GE</sub> = 0 V, V <sub>CE</sub> = 1200 V, T <sub>J</sub> = 25 °C |                         |      |      | 1    | mA   |
| C <sub>ies</sub>                 | V <sub>CE</sub> = 25 V<br>V <sub>GE</sub> = 0 V                         | f = 1 MHz               |      | 1.95 |      | nF   |
| C <sub>oes</sub>                 |                                                                         | f = 1 MHz               |      | 0.16 |      | nF   |
| C <sub>res</sub>                 |                                                                         | f = 1 MHz               |      | 0.12 |      | nF   |
| Q <sub>G</sub>                   | V <sub>GE</sub> = - 8 V...+ 15 V                                        |                         |      | 200  |      | nC   |
| R <sub>Gint</sub>                | T <sub>J</sub> = 25 °C                                                  |                         |      | 0    |      | Ω    |
| t <sub>d(on)</sub>               | V <sub>CC</sub> = 600 V                                                 | T <sub>J</sub> = 150 °C |      | 30   |      | ns   |
| t <sub>r</sub>                   | I <sub>C</sub> = 35 A                                                   | T <sub>J</sub> = 150 °C |      | 35   |      | ns   |
| E <sub>on</sub>                  | R <sub>G on</sub> = 18 Ω                                                | T <sub>J</sub> = 150 °C |      | 4.3  |      | mJ   |
| t <sub>d(off)</sub>              | R <sub>G off</sub> = 18 Ω                                               | T <sub>J</sub> = 150 °C |      | 300  |      | ns   |
| t <sub>f</sub>                   |                                                                         | T <sub>J</sub> = 150 °C |      | 55   |      | ns   |
| E <sub>off</sub>                 | V <sub>GE</sub> = +15/-15 V                                             | T <sub>J</sub> = 150 °C |      | 3.25 |      | mJ   |
| R <sub>th(j-s)</sub>             | per IGBT, λ <sub>paste</sub> =0.8 W/(mK)                                |                         |      | 1    |      | K/W  |
| R <sub>th(j-s)</sub>             | per IGBT, λ <sub>paste</sub> =2.5 W/(mK)                                |                         |      | 0.82 |      | K/W  |
| Inverse - Diode                  |                                                                         |                         |      |      |      |      |
| V <sub>F</sub> = V <sub>EC</sub> | I <sub>F</sub> = 35 A                                                   | T <sub>J</sub> = 25 °C  |      | 2.30 | 2.62 | V    |
|                                  | V <sub>GE</sub> = 0 V<br>chipelevel                                     | T <sub>J</sub> = 150 °C |      | 2.29 | 2.62 | V    |
| V <sub>F0</sub>                  | chipelevel                                                              | T <sub>J</sub> = 25 °C  |      | 1.30 | 1.50 | V    |
|                                  |                                                                         | T <sub>J</sub> = 150 °C |      | 0.90 | 1.10 | V    |
| r <sub>F</sub>                   | chipelevel                                                              | T <sub>J</sub> = 25 °C  |      | 29   | 32   | mΩ   |
|                                  |                                                                         | T <sub>J</sub> = 150 °C |      | 40   | 43   | mΩ   |
| I <sub>RRM</sub>                 | I <sub>F</sub> = 35 A                                                   | T <sub>J</sub> = 150 °C |      | 34   |      | A    |
| Q <sub>rr</sub>                  | di/dt <sub>off</sub> = 1250 A/μs                                        | T <sub>J</sub> = 150 °C |      | 5.6  |      | μC   |
| E <sub>rr</sub>                  | V <sub>GE</sub> = -15 V<br>V <sub>CC</sub> = 600 V                      | T <sub>J</sub> = 150 °C |      | 2.4  |      | mJ   |
| R <sub>th(j-s)</sub>             | per Diode, λ <sub>paste</sub> =0.8 W/(mK)                               |                         |      | 1.2  |      | K/W  |
| R <sub>th(j-s)</sub>             | per Diode, λ <sub>paste</sub> =2.5 W/(mK)                               |                         |      | 1    |      | K/W  |
| Freewheeling - Diode             |                                                                         |                         |      |      |      |      |
| V <sub>F</sub> = V <sub>EC</sub> | I <sub>F</sub> = 35 A                                                   | T <sub>J</sub> = 25 °C  |      | 2.30 | 2.62 | V    |
|                                  | V <sub>GE</sub> = 0 V<br>chipelevel                                     | T <sub>J</sub> = 150 °C |      | 2.29 | 2.62 | V    |
| V <sub>F0</sub>                  | chipelevel                                                              | T <sub>J</sub> = 25 °C  |      | 1.30 | 1.50 | V    |
|                                  |                                                                         | T <sub>J</sub> = 150 °C |      | 0.90 | 1.10 | V    |
| r <sub>F</sub>                   | chipelevel                                                              | T <sub>J</sub> = 25 °C  |      | 29   | 32   | mΩ   |
|                                  |                                                                         | T <sub>J</sub> = 150 °C |      | 40   | 43   | mΩ   |
| I <sub>RRM</sub>                 | I <sub>F</sub> = 35 A                                                   | T <sub>J</sub> = 150 °C |      | 34   |      | A    |
| Q <sub>rr</sub>                  | di/dt <sub>off</sub> = 1250 A/μs                                        | T <sub>J</sub> = 150 °C |      | 5.6  |      | μC   |
| E <sub>rr</sub>                  | V <sub>GE</sub> = -15 V<br>V <sub>CC</sub> = 600 V                      | T <sub>J</sub> = 150 °C |      | 2.4  |      | mJ   |
| R <sub>th(j-s)</sub>             | per Diode, λ <sub>paste</sub> =0.8 W/(mK)                               |                         |      | 1.2  |      | K/W  |
| R <sub>th(j-s)</sub>             | per Diode, λ <sub>paste</sub> =2.5 W/(mK)                               |                         |      | 1    |      | K/W  |

# SKiiP 24NAB12T4V1



MiniSKiiP® 2

## Converter-Inverter-Brake (CIB)

### SKiiP 24NAB12T4V1

#### Features\*

- Trench 4 IGBTs
- Robust and soft switching freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognized: File no. E63532

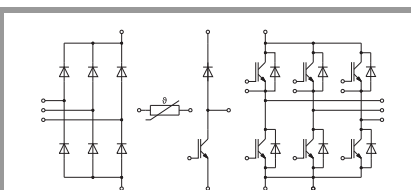
#### Typical Applications

- Inverter up to 22 kVA
- Typical motor power 11 kW

#### Remarks

- Case temp. limited to  $T_C = 125^\circ\text{C}$  max. (for baseplateless modules  $T_C = T_S$ )
- product rel. results valid for  $T_j \leq 150$  (recomm.  $T_{op} = -40 \dots +150^\circ\text{C}$ )

| Characteristics                  |                                                                                                                                                                |                         |      |           |      |      |
|----------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------|------|-----------|------|------|
| Symbol                           | Conditions                                                                                                                                                     |                         | min. | typ.      | max. | Unit |
| Rectifier - Diode                |                                                                                                                                                                |                         |      |           |      |      |
| V <sub>F</sub> = V <sub>EC</sub> | I <sub>F</sub> = 13 A                                                                                                                                          | T <sub>j</sub> = 25 °C  |      | 1.00      | 1.21 | V    |
|                                  | chiplevel                                                                                                                                                      | T <sub>j</sub> = 125 °C |      | 0.90      | 1.10 | V    |
| V <sub>F0</sub>                  | chiplevel                                                                                                                                                      | T <sub>j</sub> = 25 °C  |      | 0.88      | 0.98 | V    |
|                                  |                                                                                                                                                                | T <sub>j</sub> = 125 °C |      | 0.73      | 0.83 | V    |
| r <sub>F</sub>                   | chiplevel                                                                                                                                                      | T <sub>j</sub> = 25 °C  |      | 9.2       | 18   | mΩ   |
|                                  |                                                                                                                                                                | T <sub>j</sub> = 125 °C |      | 13        | 21   | mΩ   |
| I <sub>R</sub>                   | T <sub>j</sub> = 145 °C, V <sub>RRM</sub>                                                                                                                      |                         |      |           | 1.1  | mA   |
| R <sub>th(j-s)</sub>             | per Diode, λ <sub>paste</sub> =0.8 W/(mK)                                                                                                                      |                         |      | 1.25      |      | K/W  |
| R <sub>th(j-s)</sub>             | per Diode, λ <sub>paste</sub> =2.5 W/(mK)                                                                                                                      |                         |      | 1.1       |      | K/W  |
| Module                           |                                                                                                                                                                |                         |      |           |      |      |
| M <sub>s</sub>                   | to heat sink                                                                                                                                                   |                         | 2    |           | 2.5  | Nm   |
| w                                |                                                                                                                                                                |                         |      | 55        |      | g    |
| L <sub>CE</sub>                  |                                                                                                                                                                |                         |      | -         |      | nH   |
| Temperature Sensor               |                                                                                                                                                                |                         |      |           |      |      |
| R <sub>100</sub>                 | T <sub>r</sub> =100°C (R <sub>25</sub> =1000Ω)                                                                                                                 |                         |      | 1670 ± 3% |      | Ω    |
| R <sub>(T)</sub>                 | R <sub>(T)</sub> =1000Ω[1+A(T-25°C)+B(T-25°C) <sup>2</sup> ]<br>, A = 7.635*10 <sup>-3</sup> °C <sup>-1</sup> ,<br>B = 1.731*10 <sup>-5</sup> °C <sup>-2</sup> |                         |      |           |      |      |



NAB

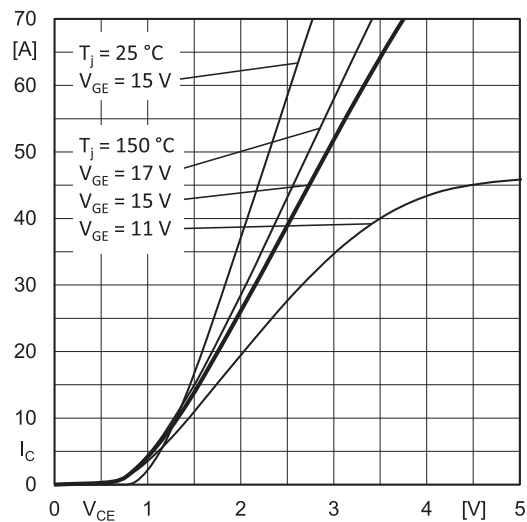


Fig. 1: Typ. output characteristic

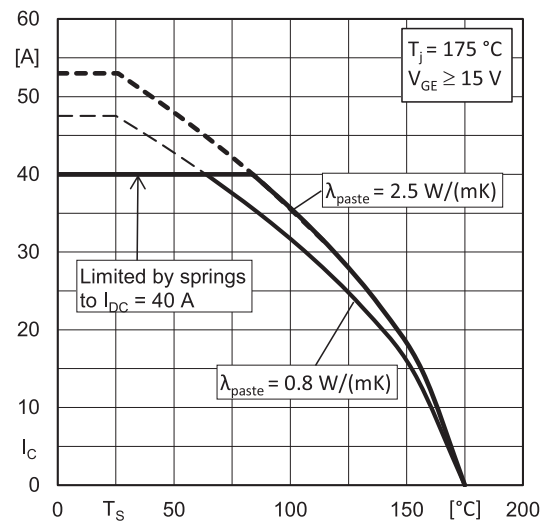


Fig. 2: Typ. rated current vs. temperature  $I_C = f(T_s)$

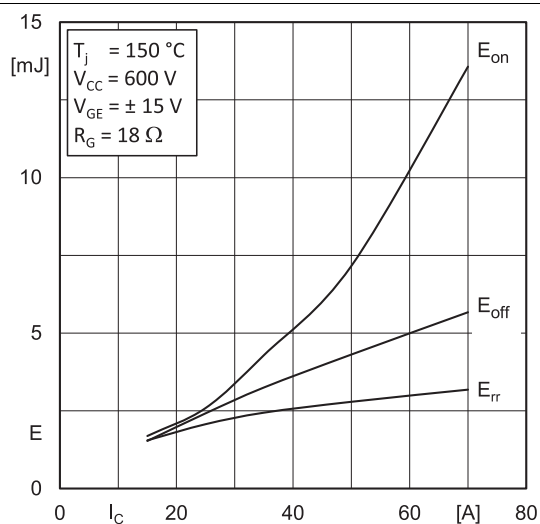


Fig. 3: Typ. turn-on /-off energy =  $f(I_C)$

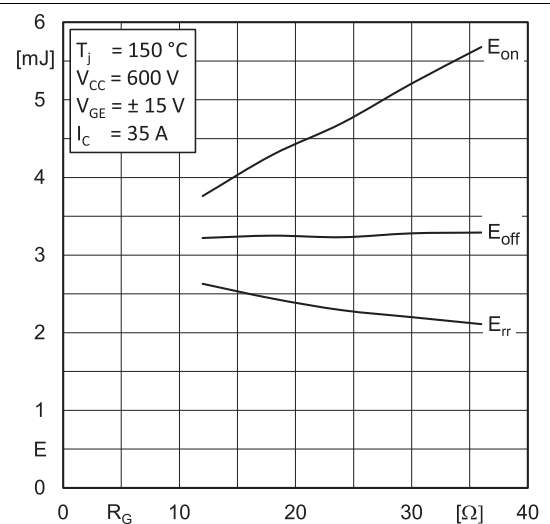


Fig. 4: Typ. turn-on /-off energy =  $f(R_G)$

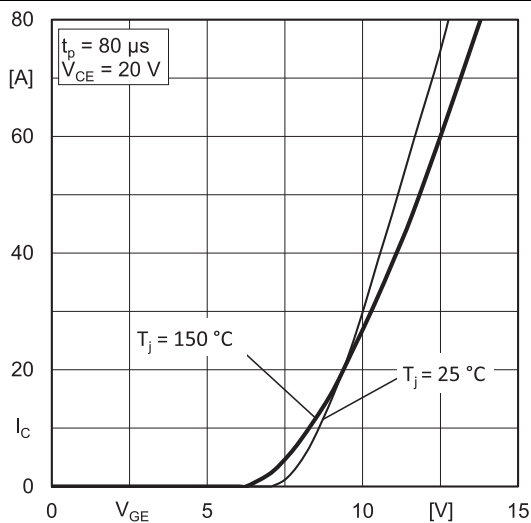


Fig. 5: Typ. transfer characteristic

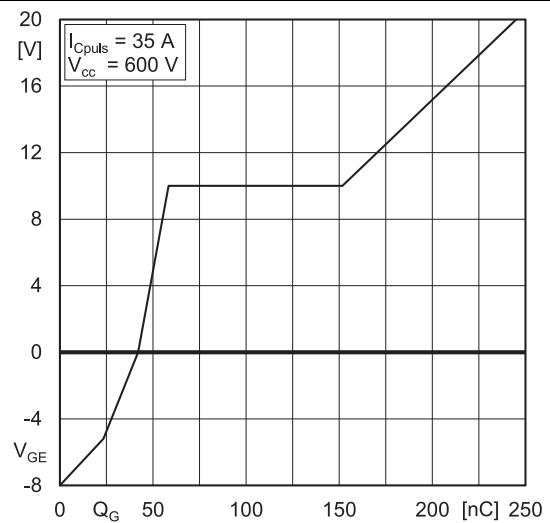
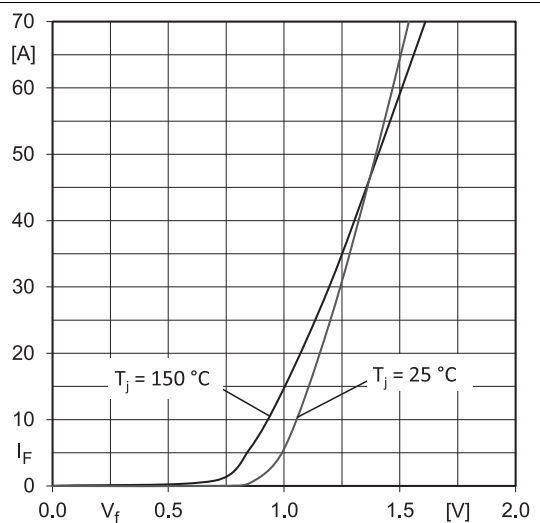
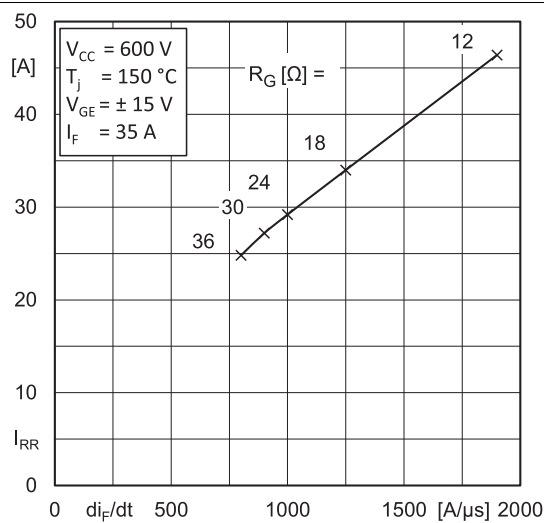
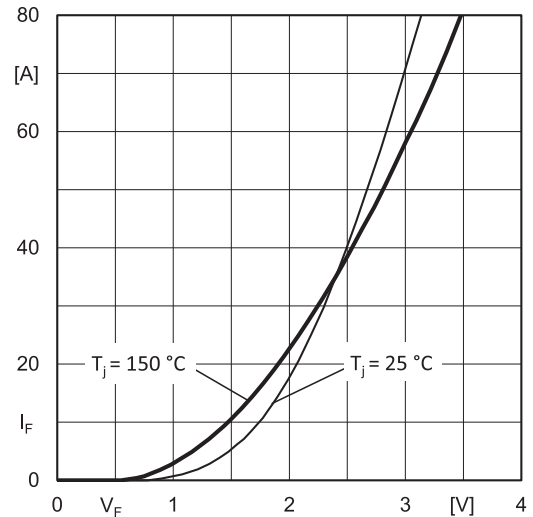
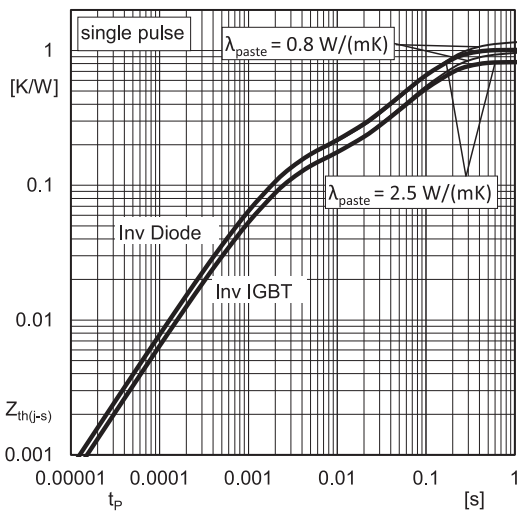
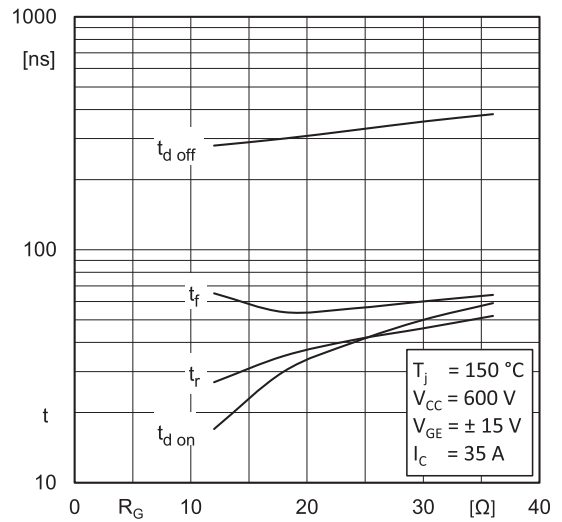
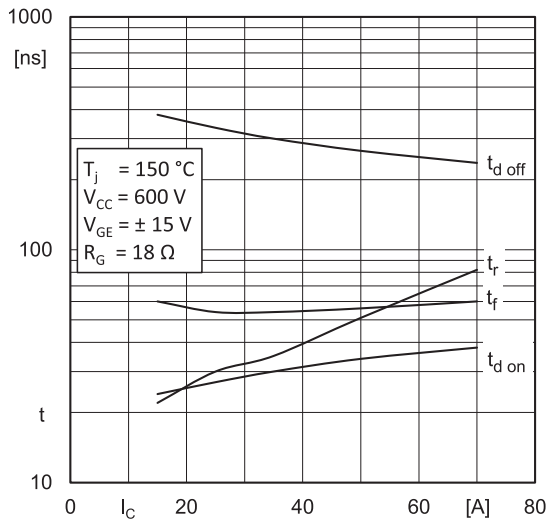
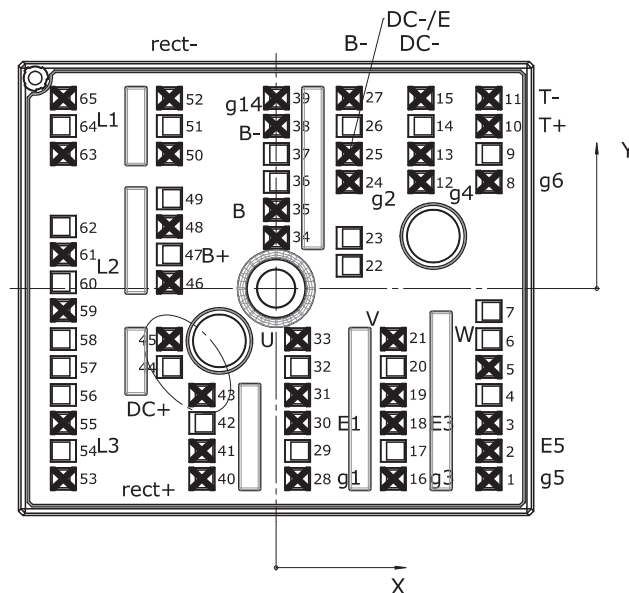


Fig. 6: Typ. gate charge characteristic

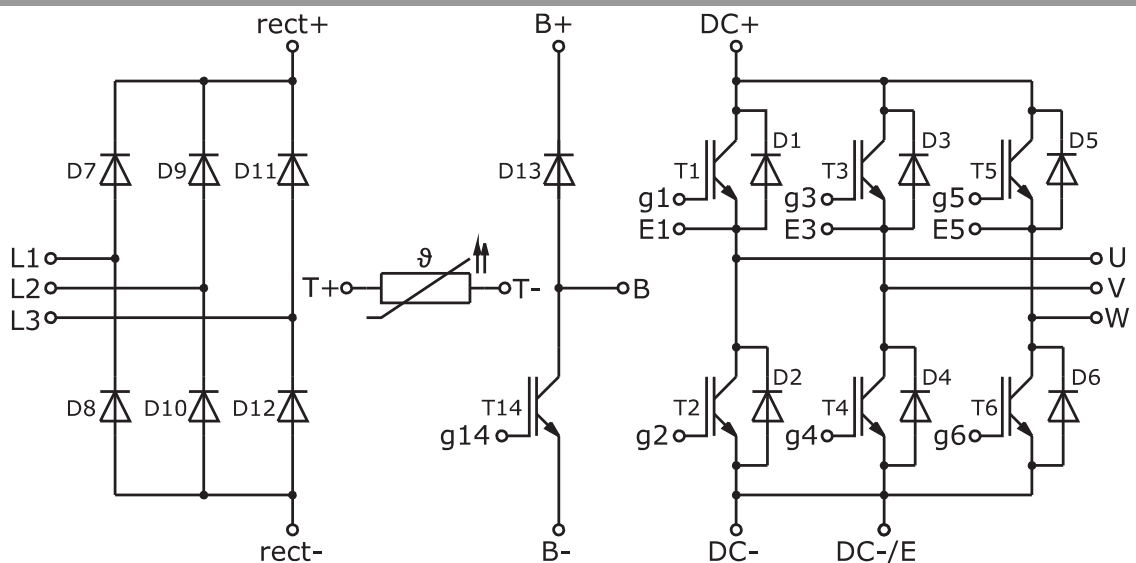


| Pin out |       |        |          |     |        |        |             |        |        |        |          |
|---------|-------|--------|----------|-----|--------|--------|-------------|--------|--------|--------|----------|
| Pin     | X     | Y      | Function | Pin | X      | Y      | Function    | Pin    | X      | Y      | Function |
| 1       | 24,38 | -21,80 | g5       | 23  | 8,38   | 5,80   | g2<br>DC-/E | 45     | -12,23 | -5,80  | DC+      |
| 2       | 24,38 | -18,60 | E5       | 24  | 8,38   | 12,20  |             | 46     | -12,23 | 0,70   | B+       |
| 3       | 24,38 | -15,40 | W        | 25  | 8,38   | 15,40  |             | 47     | -12,23 | 3,90   | B+       |
| 4       | 24,38 | -12,20 | W        | 26  | 8,38   | 18,60  | 48          | -12,23 | 7,10   | B+     |          |
| 5       | 24,38 | -9,00  |          | 27  | 8,38   | 21,80  | B-          | 49     | -12,23 |        |          |
| 6       | 24,38 | -5,80  |          | 28  | 2,46   | -21,80 | g1          | 50     | -12,23 |        | 15,40    |
| 7       | 24,38 | -2,60  | g6       | 29  | 2,46   | -18,60 | 51          | -12,23 | 18,60  | rect-  |          |
| 8       | 24,38 | 12,20  |          | 30  | 2,46   | -15,40 | E1          | 52     | -12,23 |        | 21,80    |
| 9       | 24,38 | 15,40  |          | 31  | 2,46   | -12,20 | U           | 53     | -24,38 |        | -21,80   |
| 10      | 24,38 | 18,60  | T+       | 32  | 2,46   | -9,00  | 54          | -24,38 | -18,60 | L3     |          |
| 11      | 24,38 | 21,80  | T-       | 33  | 2,46   | -5,80  | U           | 55     | -24,38 |        | -15,40   |
| 12      | 16,58 | 12,20  | g4       | 34  | 0,03   | 5,80   | B           | 56     | -24,38 |        | -12,20   |
| 13      | 16,58 | 15,40  | DC-      | 35  | 0,03   | 9,00   | B           | 57     | -24,38 | -9,00  | L2       |
| 14      | 16,58 | 18,60  | DC-      | 36  | 0,03   | 12,20  | 58          | -24,38 | -5,80  | L2     |          |
| 15      | 16,58 | 21,80  |          | 37  | 0,03   | 15,40  | 59          | -24,38 | -2,50  |        |          |
| 16      | 13,42 | -21,80 |          | g3  | 38     | 0,03   | 18,60       | B-     | 60     |        | -24,38   |
| 17      | 13,42 | -18,60 | E3       | 39  | 0,03   | 21,80  | g14         | 61     | -24,38 | 3,90   | L2       |
| 18      | 13,42 | -15,40 |          | 40  | -8,51  | -21,80 | rect+       | 62     | -24,38 | 7,10   |          |
| 19      | 13,42 | -12,20 |          | V   | 41     | -8,51  | -18,60      | rect+  | 63     | -24,38 |          |
| 20      | 13,42 | -9,00  | V        | 42  | -8,51  | -15,40 | 64          | -24,38 | 18,60  |        |          |
| 21      | 13,42 | -5,80  |          | 43  | -8,51  | -12,20 | DC+         | 65     | -24,38 | 21,80  |          |
| 22      | 8,38  | 2,60   |          | 44  | -12,23 | -9,00  |             |        |        |        |          |

all values in mm



## Pinout and Dimensions



## Pinout

This is an electrostatic discharge sensitive device (ESDS) due to international standard IEC 61340.

## **\*IMPORTANT INFORMATION AND WARNINGS**

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